

Dear customer

ROHM Co., Ltd. ("ROHM"), on the 1st day of April, 2024, has absorbed into merger with 100%-owned subsidiary of LAPIS Technology Co., Ltd.

Therefore, all references to "LAPIS Technology Co., Ltd.", "LAPIS Technology" and/or "LAPIS" in this document shall be replaced with "ROHM Co., Ltd." Furthermore, there are no changes to the documents relating to our products other than the company name, the company trademark, logo, etc.

Thank you for your understanding.

ROHM Co., Ltd. April 1, 2024





FEDL22Q244-04

Issued: Oct. 25, 2024

ML22Q244

ADPCM Speech Synthesis LSI

■ GENERAL DESCRIPTION

ML22Q244 is a speech synthesis LSI that incorporates Flash for storing sound code data, and can be controlled with a standalone interface.

By integrating D-class speaker amplifier, solution required for sound output is made possible with single chip.

• Playback time

Produ	ıct name	Flash capacity (bit)	Maximum playback time (sec) (at fs*1 = 6.4 kHz)			
1 1000	iot riairio	Tiasir capacity (bit)	HQ-ADPCM	16-bit Straight PCM		
ML22Q244		692K (when 30 phrases are selected)	34.6	6.92		
		688K (when 62 phrases are selected)	34.4	6.88		

Notes: Flash capacity shows the numerical value of only a sound area

*1: Sampling frequency

• Speech synthesis algorithm: HQ-ADPCM

4-bit ADPCM2 8-bit Nonlinear PCM 8-bit / 16-bit Straight PCM (Can be specified for each phrase)

• Flash capacity: 692 Kbit (30 phrases selection), 688Kbit (62 phrases selection)

• Sampling frequency (Fs): 6.4kHz, 8.0kHz, 10.7kHz, 12.8kHz, 16.0kHz,

21.3kHz, 25.6kHz, 32.0kHz (Can be specified for each phrase) D-class amplifier (driven by 8 Ω)

• CPU command interface: Standalone interface (built-in noise removal function)

• Maximum number of phrases: 30 phrases or 62 phrases

Disconnection detection functionSpeaker pin short detection function

Speaker driving amplifier:

• Source oscillation frequency: 8.192MHz (Typ) (internal)

Power supply voltage:
 Flash memory rewritable time:
 Operating temperature range:
 2.0 to 5.5 V
 100 times
 -40 °C to +85 °C



HQ-ADPCM is a high sound quality audio compression technology of "Ky's". "Ky's" is a Registered trademark of National Universities corporate Kyushu Institute of Technology



Applications

• Consumer and Industrial equipment (e.g., Household appliances, Housing equipment, Office equipment, Measurement instrumentation, etc.).

[NOTE]

This product cannot be applicable for automotive use, automatic train control systems, and railway safety systems. Please contact ROHM sales office in advance if contemplating the integration of this product into applications that requires high reliability, such as transportation equipment for ships and railways, communication equipment for trunk lines, traffic signal equip.

■ Table format

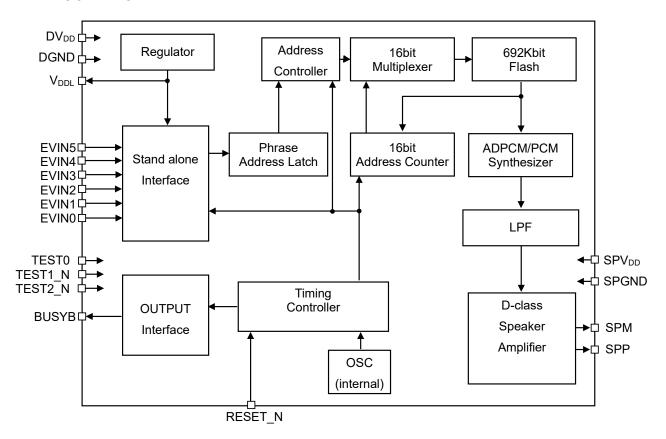
Dookogo			Pin pitch	Packing form and Product name*1		
Package	;	(including lead) [mm × mm]	[mm]	Tray	Tape & Reel	
20 pin plastic T	SSOP	6.5 × 4.4 (6.5 × 6.4)	0.65	ML22Q244-NNNTDZWARL ML22Q244-xxxTDZWARL	ML22Q244-NNNTDZWATL ML22Q244-xxxTDZWATL	

^{*1 &}quot;NNN" is a blank product. "xxx" denotes ROM code number.

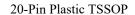
The following table shows the differences from ML22Q234, ML22Q254.

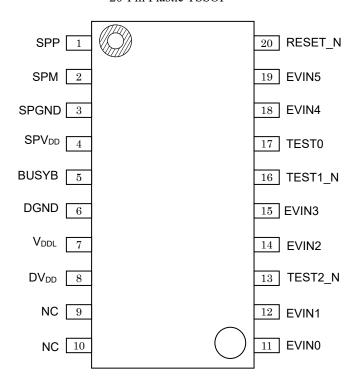
Parameter	ML22Q244 (This product)	ML22Q234	ML22Q254
MCU interface	Standalone	Clock synchronization Serial	I ² C
Flash capacity	692 Kbit (when 30 phrases are selected) 688 Kbit (when 62 phrases are selected)	676 Kbit (when 30 phrases are selected) 672 Kbit (when 62 phrases are selected)	←
Speech synthesis algorithm	HQ-ADPCM 4-bit ADPCM2 8-bit Nonlinear PCM 8-bit Straight PCM 16-bit Straight PCM	←	←
Maximum number of phrases:	30/62	←	←
Sampling frequency (kHz)	6.4/8.0/10.7/12.8/ 16.0/21.3/25.6/32.0	←	←
Clock frequency	8.192 MHz (internal oscillation)	←	←
Low-pass filter	FIR interpolation filter	←	←
Speaker driving amplifier	D-class amplifier	←	←
Speaker driving amplifier output load	8Ω	←	←
Speaker driving amplifier output voltage	1 W	←	←
Edit ROM function	Yes	←	←
Volume control	Code setting : 32 levels (Including Mute)	Code setting : 32 levels (Including Mute) Command setting : 31 levels	←
Silence insertion	4 ms to 1024 ms (4 ms/step)	←	←
Repeat function	Yes	←	←
Flash memory access function by MCU	No	Yes	←
Power supply voltage	2.0 to 5.5 V	←	←
Operating temperature range	-40 to +85°C	←	←
Package	20-pin TSSOP	←	←

■ BLOCK DIAGRAMS



■ PIN CONFIGURATIONS (TOP VIEW)





NC:Unused pin

LAPIS Technology Co., Ltd.

ML22Q244

■ PIN DESCRIPTION

Pin	Symbol	I/O	Initial value (At the RESET_N Input)	Initial value (At standby)	Description
1	SPP	0	Hi-Z	Hi-Z	Positive (+) output pin of the speaker amplifier built-in
2	SPM	0	Hi-Z	Hi-Z	Negative (-) output pin of the speaker amplifier built-in.
3	SPGND	-	-	-	Ground pin for the speaker amplifier.
4	SPV _{DD}	ı	-	-	Power supply pin for the speaker amplifier Connect a bypass capacitor of 1 μ F $\pm 30\%$ or more between this pin and SPGND pin.
5	BUSYB	0	Hi-Z	*1	BUSY output pin. When BUSYB use mode is set, the "L" level is outputted during playback. When disconnection is detected with disconnection detection function, the "L" level is outputted. BUSYB unused mode and logic inversion can be set with Speech LSI Utility.
6	DGND	-	-	-	Digital ground pin.
7	V_{DDL}	-	-	-	Regulator output pin for internal logic circuitry. Connect a capacitor of 1 µF ±30% between this pin and DGND pin
8	DV _{DD}	-	-	-	Digital power supply pin. Connect a capacitor of 1 µF ±30% or more between this pin and DGND pin.
11	EVIN0	ı			
12	EVIN1	I			Command input pin.
14	EVIN2	ı	*1	*1	Sound can be played back and stopped based on a change in a signal
15	EVIN3	ı	<u>'</u>	'	input to EVIN5-0 pin. The pin state can be set with Speech LSI Utility.
18	EVIN4	ı			Select pull-down input, pull-up input, or high impedance input
19	EVIN5	ı			
13	TEST2_N	-	1	1	Input pin for testing. This pin has a pull-up resistor built in. Fix this pin to DV_DD .
16	TEST1_N	ļ	1	1	Input pin for testing. This pin has a pull-up resistor built in. Fix this pin to DV_DD .
17	TEST0	I/O	0	0	Input/output pin for testing. Non connection.
20	RESET_N	ı	0	1	Reset input pin. This pin has a pull-up resistor built in. Input "L" level for initialization, when power is turned on, or when voltage falls below recommended operation power supply voltage range. After the power supply voltage is stable, drive this pin to "H" level.
9	N.C.	-	-	-	Unused pin. Leave this pin open.

¹⁰ Leave this pin open.

*1: This value depends on Speech LSI Utility setting. Please refer to a "Code Option Setting Item" for details.

■ ABSOLUTE MAXIMUM RATINGS

(DGND = SPGND = 0 V)

Parameter	Symbol	Condition Rating		Unit
Power supply voltage	DV _{DD} SPV _{DD}		-0.3 to + 6.5	V
Internal logic power supply voltage	V _{DDL}	Ta = 25 °C -0.3 to +2.0		V
Input voltage	V _{IN}		-0.3 to V _{DD} +0.3	V
Power dissipation	PD		1	W
Output short-circuit current	Isc ₁	Applied to pin other than SPP or SPM	-12 to +11	mA
	I _{SC2}	SPP pin, SPM pin	600	mA
Storage temperature	T _{STG}	55 to +150		°C

■ RECOMMENDED OPERATING CONDITIONS

(DGND = SPGND = 0 V)

			(בי מאוטים)	SPGND - UV)
Parameter	Symbol	Condition	Range	Unit
	DV _{DD}	-	2.0 to 5.5	
Power supply voltage	SPV _{DD}	Flash memory write	2.2 to 5.5	V
Flash memory rewrite cycles *1	N	-	100	times
Operating temperature range	T _{OP1}	-	-40 to +85	°C
Operating temperature range	T _{OP2}	Flash memory write	0 to +40	
Capacitor externally connected to DV _{DD} pin	C _V	-	1±30% or more	μF
Capacitor externally connected to SPV _{DD} pin	Csv	-	1±30% or more	μF
Capacitor externally connected to V _{DDL} pin	CL	-	1±30%	μF
FLASH Memory write cycle	Y _{DR}	-	15	years

^{*1:} It means one erase and one program. Even when erasing is interrupted, it counts as one time.

■ ELECTRICAL CHARACTERISTICS

DC Characteristics

		$DV_{DD} = SPV_{DD} = 2.0 \text{ to } 5.5 \text{ V},$	DGND = SF	PGND = 0 V	, Ta = -40 to	+85°C	
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit	
"H" input voltage	VIH	-	$0.7 \times DV_{DD}$	-	DV_DD	V	
"L" input voltage	VIL	-	0	-	$0.3 \times DV_{DD}$	V	
"H" output voltage 1	V _{OH1}	$I_{OH} = -0.5 \text{ mA}$	DV _{DD} -0.5	-	-	V	
"L" output voltage 1	V _{OL1}	$I_{OL} = 0.5 \text{mA}$	-	-	0.5	V	
"H" input current 1	I _{IH1}	$V_{IH} = DV_{DD}$	-	-	1	μA	
"H" input current 2	I _{IH2}	V _{IH} = DV _{DD} TEST0 pin	0.02	0.3	1.5	mA	
"H" input current 3	Іінз	$V_{IH} = DV_{DD}$ EVIN5-0 terminal pull-up input is set	2	30	250	μΑ	
"L" input current 1	I _{IL1}	V _{IL} = DGND	-1	-	-	μΑ	
"L" input current 2	I _{IL2}	V _I L = DGND RESET_N pin, TEST1_N	-1.5	-0.3	-0.02	mA	
"L" input current 3	I _{IL3}	V _{IL} = DGND TEST2_N EVIN5-0 terminal pull-up input is set	-250	-30	-2	μΑ	
"H" output current 1	Іоон1	VOH= DV_{DD} = SPV_{DD} (High impedance) BUSYB, SPP, SPM pin	-	-	1	μA	
"H" output current 2	I _{OOH2}	VOH= DV _{DD} (Nch Open drain) BUSYB pin	-	-	1	μA	
"L" output current 1	lool1	VOL=DGND=SPGND (High impedance) BUSYB, SPP, SPM pin	-1	-	-	μA	
"L" output current 2	I _{OOL2}	VOL=DGND (Pch Open drain) BUSYB pin	-1	-	-	μA	
Supply current during	I _{DD1}	No output load DVDD= SPVDD=3.0 V	-	3.0	6.0	mΛ	
playback	I _{DD2}	No output load DVpp= SPVpp=5.0 V	-	5.0	9.0	mA	
Supply current during stabilizing chattering	I _{DDC1}	DV _{DD} = SPV _{DD} =5.0 V	-	2.0	3.5	mA	
Standby supply current	I _{DDS1}	Ta ≤ 50°C	-	0.5	3.0		
Clandby Supply Current	I _{DDS2}	Ta ≤ 85°C	-	0.5	8.0	μA	
Source oscillation frequency	fosc	-10 to +50°C	8.069	8.192	8.315	MHz	
Source Communer Hoquertoy	IOSC	-40 to +85°C	7.946	8.192	8.438	IVITIZ	

• Characteristics of Analog Circuitry

		$DV_{DD} = SPV_{DD} = 2.0 \text{ to}$	5.5 V, DGND	= SPGND = 0	V, Ta = -40 to	o +85°C
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
SPM, SPP output load resistance	RLSP	-	8	-	-	Ω
Speaker amplifier output voltage	Pspo	SPV _{DD} = 5.0 V, Sin wave f = 1 kHz R _{LSP} = 8 Ω. THD ≥ 10%	-	1.0	-	W

• Power-on/Shutdown Sequence

 DV_{DD} = SPV_{DD} = 2.0 to 5.5 V, DGND = SPGND = 0 V, Ta = -40 to +85°C

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
RESET_N input pulse width at Power on	t RSTR	-	100	-	-	μs
RESET_N input pulse width at shut down	t RSTF	-	0	-	-	μs

AC Characteristics

 DV_{DD} = SPV_{DD} = 2.0 to 5.5 V, DGND = SPGND = 0 V, Ta = -40 to +85°C

Di	DD - SPVDD	- 2.0 to 5.5 V, DGND -	- OF GINL) – U V, I	a – -4 0 ll) +05 C
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Initialization time after reset release	t _{INIT}	-	-	-	65	ms
Oscillation stabilization time	t _{PUP1}	-	-	1	2	ms
Playback time	tvcyc	-	20	-	-	ms
Chattering removal time*1	t _{SP}	Initial value (08 h)	Typ2	16	Typ.+2	ms
Command processing time	t _{B1}	-	-	-	400	μs
Oscillation stop time, after playback	tosst	-	-	-	500	μs
Next command transmit time□ In the case of the playback	t _{NCM}	-	-	-	10	ms
Next command transmit time after shifting to a standby state	t _{CMS}	-	50	-	-	ns
Disconnection judging by the DISCONNECT command start time	tocos	-	1.5	-	-	ms
Disconnection judging by the DISCONNECT command end time	tDCDE	-	-	-	1	S
BUSYB change time from "L" to "H", after over-current detection of a speaker amplifier	t _{SD}	-	-	-	160	μs
Processing time before playback start	t _{PLBF}	-	0.3	-	2.1	ms
Processing time after playback start	t _{PLAF}	-	0.15	-	1.2	ms
Fade-out time at Change Immediately mode or Change Immediately Once mode	t _{FDO}	-	_	22	-	ms

^{*1:} Can be set within a range from 0 ms to 62 ms with Speech LSI Utility.

Note: Output pin load capacitance = 45 pF (max.)

■ PLAYBACK FUNCTION

• Standalone interface

Standby is canceled by a change in a signal input to the EVIN5-0 pin, and after the chattering removing period, an operation corresponding to a command indicated by the EVIN5-0 pin starts.

The pin status of the EVIN5-0 can be selected among high-impedance input (Hi-Z), pull-down input (PullDown), and pull-up input (PullUp).

The pin status of the EVIN5-0 pin is selected using Speech LSI Utility. Please refer to a "Code Option Setting Item" for details.

Chattering removal time

Chattering removal time can be set for preventing erroneous operation due to chattering when the EVIN5-0 pin changes. The time can be set from 2 ms to 62 ms (setting value: 01h to 1Fh) in increments of 2 ms. The initial value is 16 ms (08h).

Chattering removal time = $(2^4*bit4+2^3*bit3+2^2*bit2+2^1*bit1+2^0*bit0)*2$ ms

Set a setting value 10h to set the time to be 32 ms.

Chattering removal time = $2^4*1+2^3*0+2^2*0+2^1*0+2^0*0$)*4 ms = 8*2 ms = 32 ms

The chattering removal time is selected using Speech LSI Utility. Please refer to a "Code Option Setting Item" for details.

· Speech synthesis algorithm

Supporting four types of Speech Synthesis algorithms, which are HQ-ADPCM, 4bit ADPCM2, 8-bit nonlinear PCM, 8-bit Straight PCM, and 16-bit Straight PCM. Any of these can be selected based on the characteristics of the sound to be played back.

Speech Synthesis method	Compression rate*1	Suitable waveform	Characteristics
HQ-ADPCM	1/5	Sound including high frequency components (such as sound effects)	4bit ADPCM2 algorithm is improved. Adopting variable bit length enables high sound quality and high data compression.
4-bit ADPCM2	1/4	Normal voice sound wave	Unique scheme which is a refined version of 4bit ADPCM Offers higher sound quality with better waveform followability.
8-bit Nonlinear PCM	1/2	Sound including high	A part around the center of the waveform is played back with a sound quality equivalent to 10 bits.
8-bit Straight PCM	1/2	frequency components (such as sound effects)	Normal 8-bit Straight PCM.
16-bit Straight PCM	1	(Suon as sound enects)	Normal 16-bit Straight PCM.

^{*1:} When the same sampling frequency is used.

• Memory Allocation and Creating Sound Code Data

The sound code data consists of a sound management area, a sound data area, and an edit ROM area.

The sound control area manages setting information for 30 phrases or 62phrases.

The sound area contains actual waveform data.

The edit ROM area contains data for effective use of sound data. For the details, refer to the section of "Edit ROM Function". The edit ROM area only available when the edit ROM is used.

The ROM data is created using Speech LSI Utility.

Please refer to a "Code Option Setting Item" for details.

Sound code data configuration (when 30 phrases are selected)

0x00000 Sound control area 0x001FF 0x00200 Sound data area / Edit ROM area*1

Sound code data configuration (when 62 phrases are selected)

0x00000	
	Sound control area
0x003FF	
0x00400	
	Sound data area /
	Edit ROM area ^{*1}
0x159FF	

^{*1:} Edit ROM area depends on creation of the data

• Playback Time and Flash Capacity

The playback time depends on the memory capacity, sampling frequency, and the playback method. The equation to know the playback time is shown below. But this is not applied if the edit ROM function is used.

In the case that the sampling frequency is 8 kHz, algorithm is HQ-ADPCM, the playback time is as follows.

When 30 phrases are selected

Playback time=
$$\frac{1.024 \times 692 (\text{Kbit})}{8 (\text{kHz}) \times 3.2 (\text{bit})} \approx 27.6 [\text{sec}]$$
When 62 phrases are selected
$$\frac{1.024 \times 688 (\text{Kbit})}{8 (\text{kHz}) \times 3.2 (\text{bit})} \approx 27.5 [\text{sec}]$$
Playback time=
$$\frac{8 (\text{kHz}) \times 3.2 (\text{bit})}{8 (\text{kHz}) \times 3.2 (\text{bit})}$$

Make the playback time of one phrase more than 20 msec.

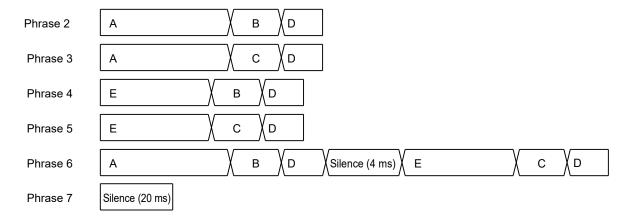
• Edit ROM function

The edit ROM function makes it possible to play back multiple phrases in succession. The following functions are set using the edit ROM function:

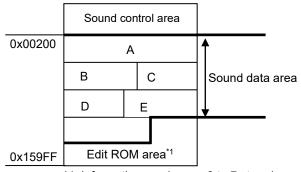
- Continuous playback: There is no limit to set the number of times of the continuous playback. It depends on the Flash capacity only.
- Silence insertion function: 4 ms to 1,024 ms
- *Note: Silent insertion time varies for ± 1 ms depends on the sampling frequency. An independent phrase generated by edit ROM shall be 20 ms or longer.

It is possible to use sound ROM effectively to use the edit ROM function. An example of the ROM structure, in a case of using the edit ROM function is as follows.

Example 1) Phrases using the Edit ROM Function



Example 2) Structure of the ROM storing contents of Example 1 (When 30 phrases are selected)



*1: Information on phrases 2 to 7 stored

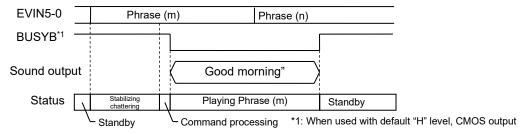
Playback mode setup

Five playback modes are available. Can be set up for every phrase. Set when the sound code data is generated.

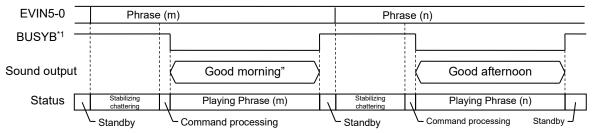
◆ Play Once mode

This mode is playback once.

All the commands become invalid during playback.



Next command must be input in the standby state after the playback ends.

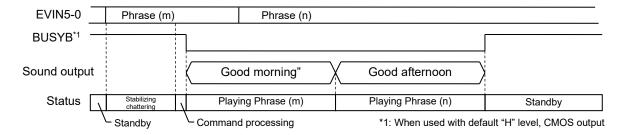


*1: When used with default "H" level, CMOS output

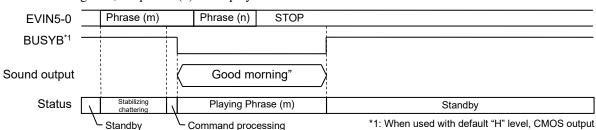
◆ Scheduled Play Once mode

This mode is playback once.

When the next command is inputted during playback, after playback of the present phrase ends, playback of the next command starts.



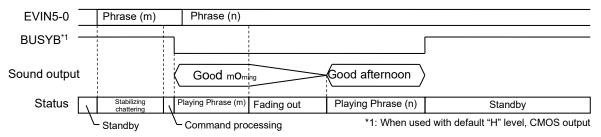
When a plurality of commands are inputted, the last command input at the end of the phrase is valid. In the following case, the phrase (n) is not played back because the last command is STOP command.



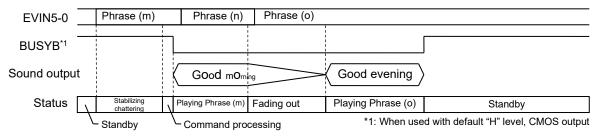
◆ Change Immediately Once mode

This mode is for playing back once.

When the following phrase is inputted into playback, playback of the present phrase is ended on the way, and playback of the following phrase starts.



When a plurality of commands are inputted, the last command input at the end of the phrase is valid. In the following case, the last input phrase (o) is played back.

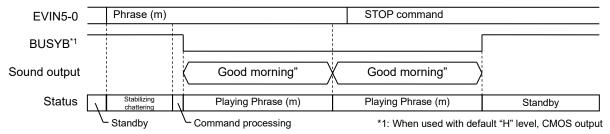


Scheduled Play mode

Once the playback starts, it is repeated until the next command is input.

The next command input during the playback is executed after the playback ends.

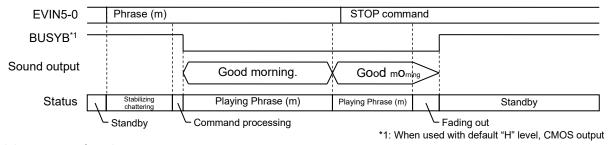
When a plurality of commands are inputted, the last command input at the end of the phrase is valid, as in Scheduled Play Once.



Change Immediately mode

Once the playback starts, it is repeated until the next command is input.

When the next command is inputted, the phrase being played back is terminated, and the next command is executed. When a plurality of commands are inputted, the last command input at the end of the phrase is valid, as in Change Immediately Once.



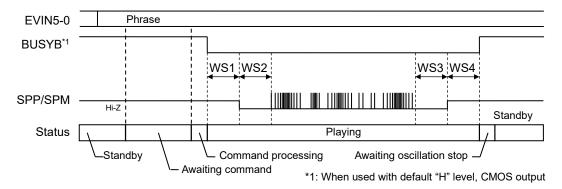
Volume setup function

Each phrase can set up the volume setup. Set when the sound code data is generated.

Value	Volume [dB]	Value	Volume [dB]	Value	Volume [dB]
00h	+2.98	0Ah	-0.41	15h	-6.87
01h	+2.70	0Bh	-0.83	16h	-7.79
02h	+2.40	0Ch	-1.28	17h	-8.82
03h	+2.10	0Dh	-1.75	18h	-9.99
04h	+1.78	0Eh	-2.25	19h	-11.34
05h	+1.45	0Fh	-2.77	1Ah	-12.94
06h	+1.11	10h	-3.34	1Bh	-14.90
07h	+0.76	11h	-3.94	1Ch	-17.44
08h	+0.39	12h	-4.58	1Dh	-21.04
09h	+0.00	13h	-5.28	1Eh	-27.31
		14h	-6.04	1Fh	OFF

Function of setting wait time before and after playback (WS1, WS2, WS3, WS4)

Wait time before playback (WS1, WS2) and after playback (WS3, WS4) can be set for each phrase. Set when the sound code data is generated.



WS1: Time after inputting a phrase address, until SPP/SPM pins are enabled.

WS2: Time after SPP/SPM pins are enabled, until playback is started.

WS3: Time after playback is completed, until SPP/SPM pins are disabled.

WS4: Time after SPP/SPM pins are disabled, until it will be in a standby state.

WS1-WS4 can be arbitrarily set up between 0 to 1020 ms (4 ms unit).

• Speaker Pin Short Detection Function

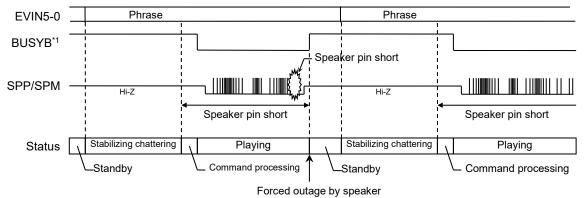
The speaker pin short detection function detect the short-circuit between SPP pin and SPM pin, or between SPP/SPM pin and GND during playback.

When short-circuit of a speaker pin is detected, the playback will be stopped automatically, BUSYB pin will become "H" level, and LSI will become in a standby state.

Speaker short detection prevents IC destruction, but the detection circuit is effective to prevent destruction caused by sudden accidents, and is not intended for use in the condition like short detection occurs continuously.

This function can be set up with the option screen of Speech Utility.

Please refer to a "Code Option Setting Item" for details.



*1: When used with default "H" level, CMOS output

■ PLAYBACK COMMANDS

• Playback commands list

The following playback commands are used for the LSI. Use the playback commands in the condition ensuring that the sound code data is set on the flash memory of this LSI.

Command	Description					
STOP	Stop command. The STOP command becomes effective for phrase other than those in Play Once mode and Scheduled Play Once mode.					
DISCONNECT	Disconnection detection command. Speaker disconnection is detected. The STOP command must be input after using the DISCONNECT command.					
PHRASE	Playback command. Playback phrase is selected from 30 phrases or 62phrases					

• Playback commands configuration

Control by EVIN4-0 and control by EVIN5-0 can be selected.

When the control by EVIN5-0 is selected, the number of phrases can be expanded to 62 phrases.

PHRASE command is allocated with a bit sequence other than the set values for STOP command and DISCONNECT command.

These are set when the sound code data is generated.

Please refer to a "Code Option Setting Item" for details.

The command configuration when the initial value (STOP command is set to be 00h and DISCONNECT command is set to be 01h) is set is as follows.

(1) Control by EVIN4-0 (30 phrases)

Command	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
STOP	*	0	0	0	0	0
DISCONNECT	*	0	0	0	0	1
	*	0	0	0	1	0
PHRASE				:		
	*	1	1	1	1	1

^{*:} EVIN5 input is disabled.

(2) Control by EVIN5-0 (62 phrases)

Command	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
STOP	0	0	0	0	0	0
DISCONNECT	0	0	0	0	0	1
	0	0	0	0	1	0
PHRASE				:		
	1	1	1	1	1	1

Any bit sequence can be set for STOP command and DISCONNECT command.

The following shows examples of a case where a non-initial value is set. When STOP command is changed from the initial value, the number of phrase available decreases by one.

(1) Control by EVIN4-0 (when STOP command is set to be 1Fh and DISCONNECT command is set to be 01h)

Command	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
*1	*	0	0	0	0	0
DISCONNECT	*	0	0	0	0	1
	*	0	0	0	1	0
PHRASE			:	:		
	*	1	1	1	1	0
STOP	*	1	1	1	1	1

^{*:} EVIN5 input is disabled.

(2) Control by EVIN5-0 (when STOP command is set to be 3Eh and DISCONNECT command is set to be 02h)

Command	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
_*1	0	0	0	0	0	0
PHRASE	0	0	0	0	0	1
DISCONNECT	0	0	0	0	1	0
	0	0	0	0	1	1
PHRASE				:		
	1	1	1	1	0	1
STOP	1	1	1	1	1	0
PHRASE	1	1	1	1	1	1

^{*1: 00}h cannot be set to PHRASE command. 61 phrases of 01h, 3Fh and from 03h to 3Dh can be set to PHRASE command.

^{*1: 00}h cannot be set to PHRASE command. 29 phrases from02h to 1Eh can be set to PHRASE command.

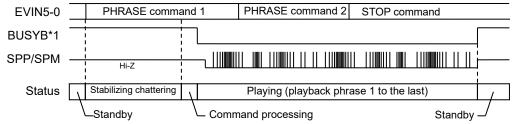
STOP command

EVIN5-0 pin	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
Initial value	0	0	0	0	0	0

The STOP command is used to stop the playback. BUSYB pin will become "H", if the playback is stopped. The STOP command becomes effective for the phrase waiting to be played in Scheduled Play Once mode, and in Scheduled Play modem, Change Immediately Once mode, and Change Immediately mode. STOP command used for phrases played back in Play Once mode or Scheduled Play Once mode, the STOP is ignored. When STOP command is input in Scheduled Play mode, the playback stops after the phrase is played back to the end. When STOP command is input in Change Immediately Once mode or Change Immediately mode, the sound fades out, and the playback stops.

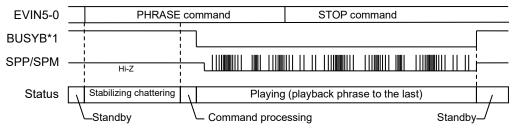
Operations where STOP command is effective are described below.

◆ STOP command operation in the case of Scheduled Play Once mode



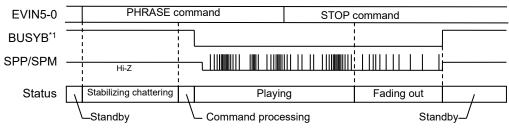
*1: When used with default "H" level, CMOS output

STOP command operation in the case of Scheduled Play mode



*1: When used with default "H" level, CMOS output

◆ STOP command operation in the case of Change Immediately Once mode or Change Immediately mode

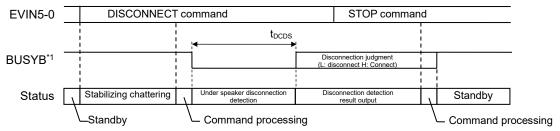


*1: When used with default "H" level, CMOS output

DISCONNECT command

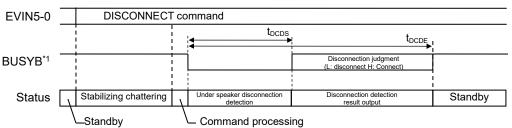
EVIN5-0 pin	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
Initial value	0	0	0	0	0	1

The DISCONNECT command is used to diagnose whether the speaker is disconnected or not. The command cannot be used during sound playback. The command shall be used during standby (no playback). Disconnection detection result is output to BYSYB pin. "L" is output when the speaker is disconnected, and outputs "H" when the speaker is not disconnected. Please input the STOP command to transition to standby state, after you use the DISCONNECT command.



*1: When used with default "H" level, CMOS output

When no STOP command is input after the execution of DISCONNECT command, the disconnection detection automatically stops in one second, and transition to standby occurs.



*1: When used with default "H" level, CMOS output

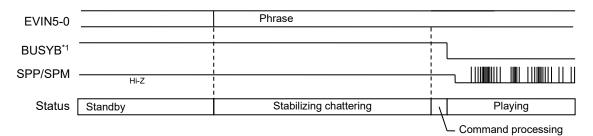
• PHRASE command

EVIN5-0 pin	
Initial value	

EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0
0	0	0	0	1	0
			:		
1	1	1	1	1	1

PHRASE command is playback command. Specifies an address of a phrase to be played back. Command that is not set to be STOP command or DISCONNECT command is set to be PHRASE command. An address of phrase to be played back is set when sound code data is generated with Speech LSI Utility.

Timings of PHRASE command are shown below.



*1: When used with default "H" level, CMOS output

Set the playback Phrase with EVIN4-EVIN0 or EVIN5-EVIN0.

(1) 1-byte command selection

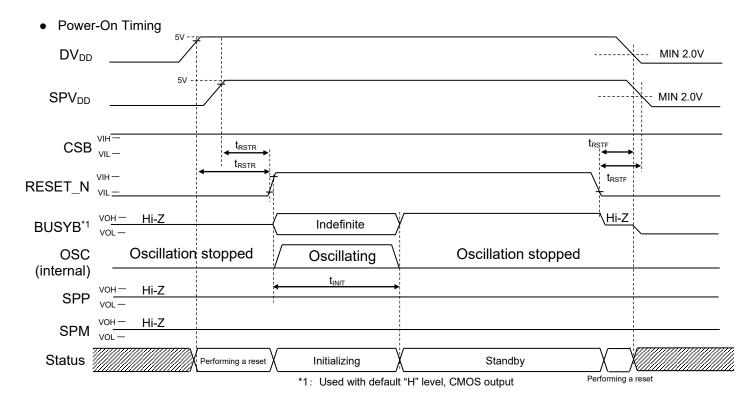
No.	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0	Playing Phrase
1	*	0	0	0	1	0	Phrase 2
:	*	:					:
30	*	1	1	1	1	1	Phrase 1F

^{*:} EVIN5 input is disabled.

(2) 2-byte command selection

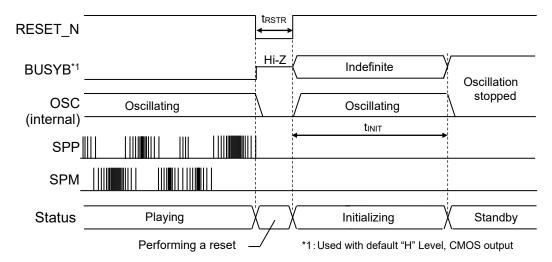
No.	EVIN5	EVIN4	EVIN3	EVIN2	EVIN1	EVIN0	Playing Phrase
1	0	0	0	0	1	0	Phrase 2
:	:						:
62	1	1	1	1	1	1	Phrase 3F

TIMING DIAGRAMS



When the power is turned on and off, there is no restriction on the order of turning on DV_{DD} and SPV_{DD} . When DV_{DD} or SPV_{DD} falls below recommended operation power supply voltage range, "L" level must be input to RESET_N pin.

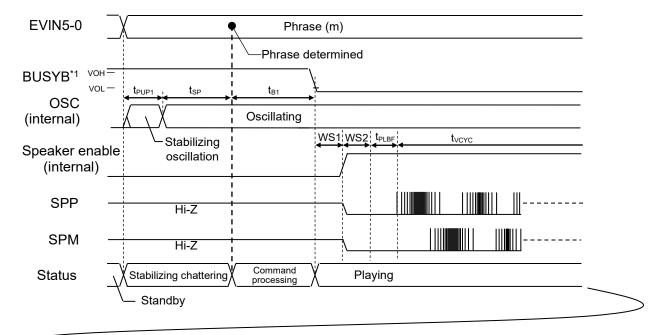
Power down timing (RESET_N pin)

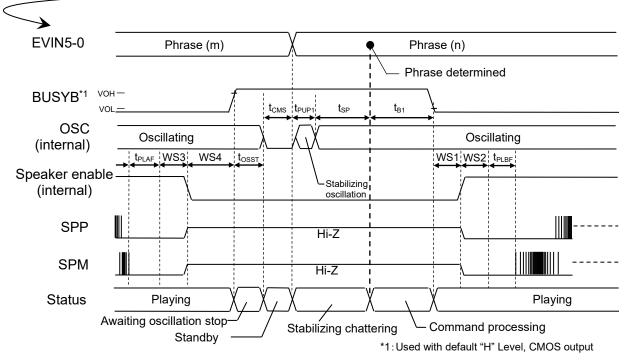


When DV_{DD} or SPV_{DD} falls below recommended operation power supply voltage range, "L" level must be input to RESET N pin.

• Play Once/Scheduled Play Once/Change Immediately Once mode timing

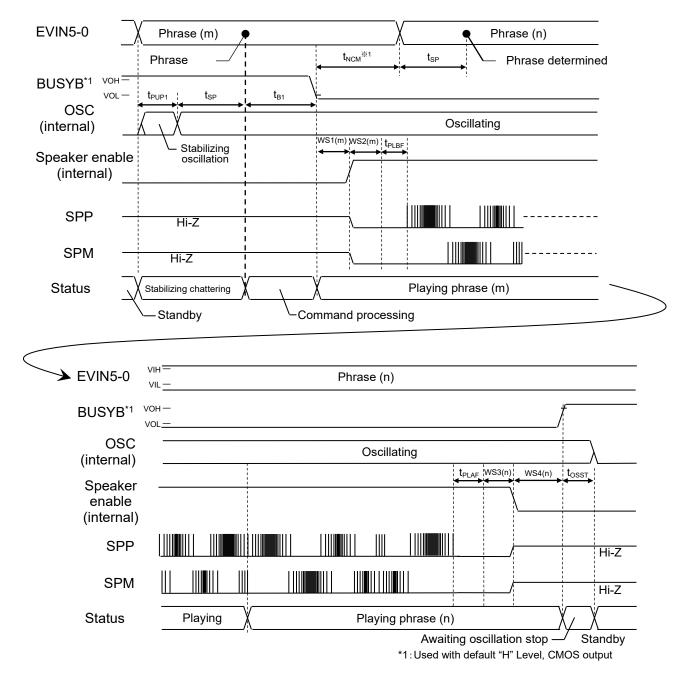
After playback of phrase (m) ends, playback request for next phrase (n) is accepted and the phrase (n) is played back. All the commands become invalid during playback of phrase (m).





• Scheduled Play Once mode and Scheduled Play mode Timing (Continuous Play)

In response to playback request for the next phrase (n), the phrase (m) is played back to the end, and then playback of the phrase (n) starts.

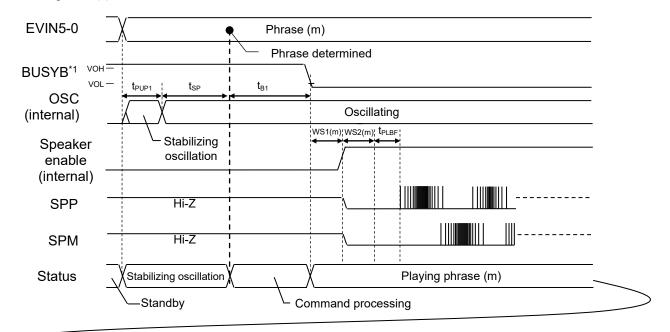


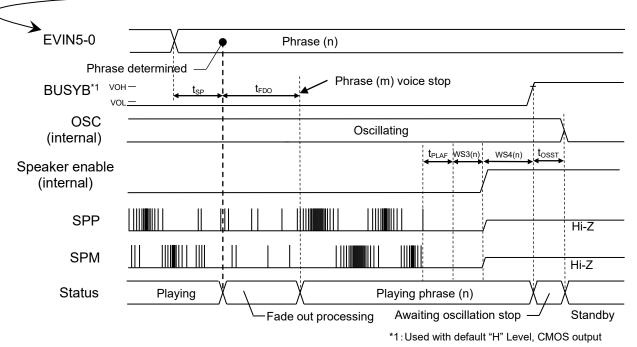
*Under Scheduled Play mode, playback is stopped by STOP command.

Note 1: In Scheduled Play Once mode, the phrase (n) is played back immediately after the end of the playback of the phrase (m), in response to an input of a playback request (PHRASE command) for the next phrase (phrase (n)) within t_{NCM} .

• Change Immediately Once mode and Change Immediately mode Timing (Continuous Play)

In response to playback request for the next phrase (n), the phrase (m) is played back to the last, and then playback of the phrase (n) starts.

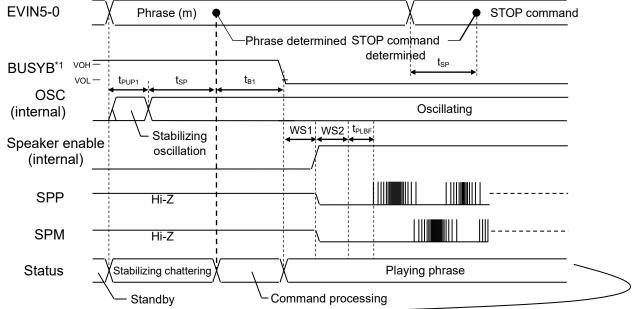




[•]Under Change Immediately mode, playback is stopped by STOP command.

• Scheduled Play Once mode and Scheduled Play mode Timing sound stop timing

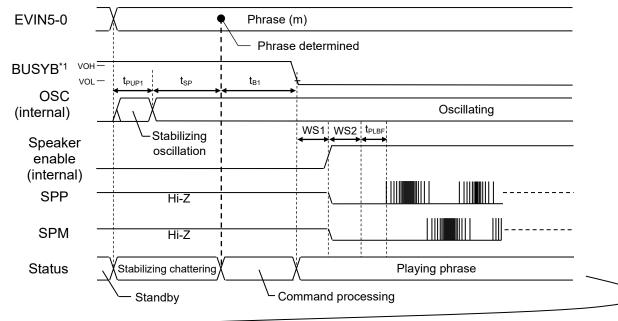
After STOP command is input, the phrase is played back until the end, and the playback stops.

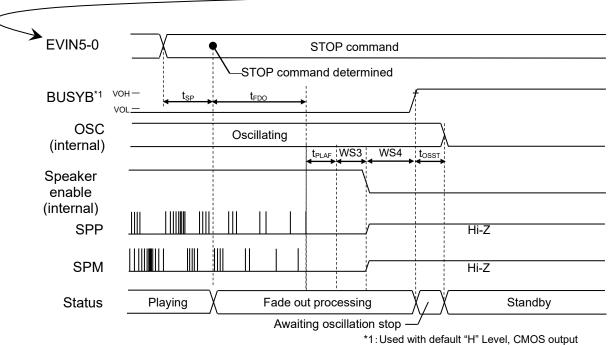


EVIN5-0 BUSYB*1 VOH-OSC Oscillating (internal) t_{PLAF} WS3(n) WS4(n) Speaker enable (internal) SPP Hi-Z SPM Hi-Z Status Playing (Play until the end of phrase) Standby Awaiting oscillation stop

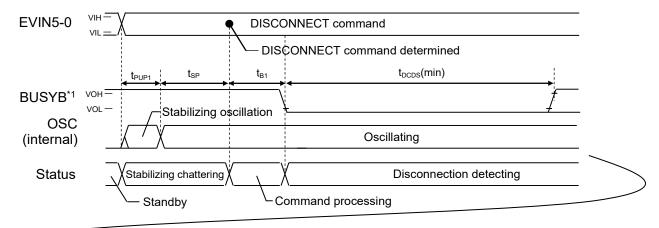
*1: Used with default "H" Level, CMOS output

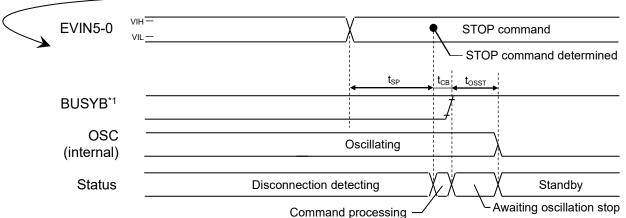
Change Immediately Once mode and Change Immediately mode sound stop timing
 After STOP command is input, the sound fades out, and the playback stops.





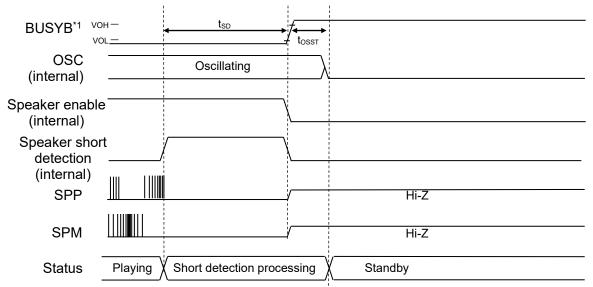
Disconnection detection timing





*1: Used with default "H" Level, CMOS output

· Speaker short detection timing



*1: Used with default "H" Level, CMOS output

■ Code Option Setting Item

Items set on Code Option Setting screen for Speech LSI Utility are as follows.

·Speaker pin short detection function

Lies of anacker pin chart detection function	☐ (Not used)
Use of speaker pin short detection function	□ (Used)

·Num of Phrases and Command type setting

Num of Phrases / Command type	○30 phrases / EVIN4-0
	(30 phrases can be played and communicate with EVIN4-0 pins)
	○62 phrases / EVIN5-0
	(62 phrases can be played and communicate with EVIN5-0 pins)

STOP/DISCONNECT Command	Command bit sequence		
⊖Standard	STOP command	Set 00h	
Standard	DISCONNECT command	Set 01h	
	STOP command	Set any bit sequence	
○Custom	DISCONNECT command	Set any bit sequence (Set value different from STOP command)	

BUSYB Pin Setting

Use of BUSYB	Initial State	Condition	BUSYB pin status
□ (Not wood)	OL level Output	*	Fixed to "L" output
□ (Not used)	OH level Output	*	Fixed to "H" output
		OCMOS	Output initial value "L" with CMOS output
	Ol Javad Outrant	○Nch Open Drain	Output initial value "L" with Nch open drain output
	○L level Output	○Pch Open Drain	Output initial value HiZ with Pch open drain output
		○Hi-Z	Hiz output
□ (Used)		OCMOS	Output initial value "H" with CMOS output
	○H level Output	○Nch Open Drain	Output initial value HiZ with Nch open drain output
		○Pch Open Drain	Output initial value "H" with Pch open drain output
		○Hi-Z	Hiz output

^{*:} Setting value invalid

•EVIN5 to EVIN0 Pins Setting

	⊖Hi-Z	Used with high impedance input
EVIN5-0	○Pull Down	Used with pull-down input
	○Pull-up	Used with pull-up input

When 30 phrases / EVIN4-0 is selected, EVIN5 input is disabled.

· Chattering removal time setting

Chattering removal time	Set chattering removal time within a range of 2 ms to 62 ms (initial value is 16 ms)

■ Phrase information Setting Item

The items to be set on the phrase info setting screen of Speech LSI Utility are as follows.

- Playback mode (EVENT Mode)
 Set playback mode suitable for target playback, with reference to "Playback mode" in FUNCTIONAL DESCRIPTION.
- •Volume setup Set playback mode suitable for target playback, with reference to "Volume setup function" in FUNCTIONAL DESCRIPTION.
- Setting Wait time before and after volume playback (WS1,WS2,WS3,WS4)
 Set desired Wait time with reference to "Function of setting wait time before and after playback (WS1, WS2, WS3, WS4)".

■ TERMINATION OF THE V_{DDL} PIN

The VDDL pin is the regulator output that is power supply pin for the internal logic circuits. Connect a capacitor between this pin and the ground in order to prevent noise generation and power fluctuation.

The recommended capacitance value is shown below. However, it is important to evaluate and decide using the own board

Also, start the next operation after each output voltage is stabilized.

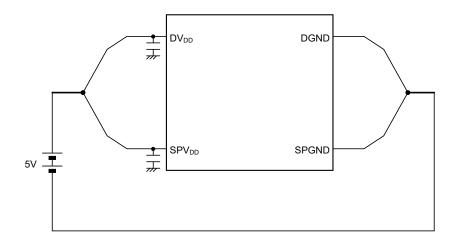
Pin	Recommended capacitance value	Remarks
V_{DDL}	1 μF ±30%	The larger the connection capacitance, the longer the settling time.

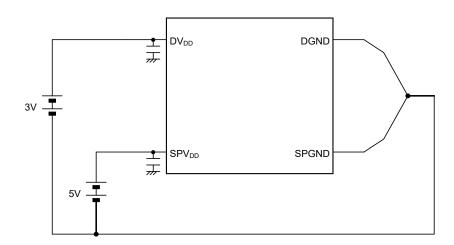
■ POWER SUPPLY WIRING

The power supplies of this LSI are divided into the following two:

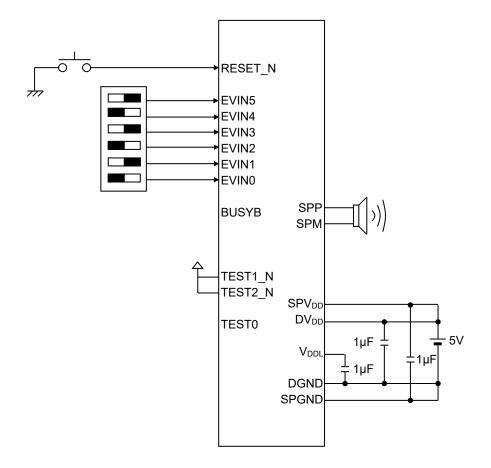
- · Power supply for logic circuitry (: DV_{DD})
- · Power supply for speaker amplifier (: SPV_{DD})

The example of power connection is shown below

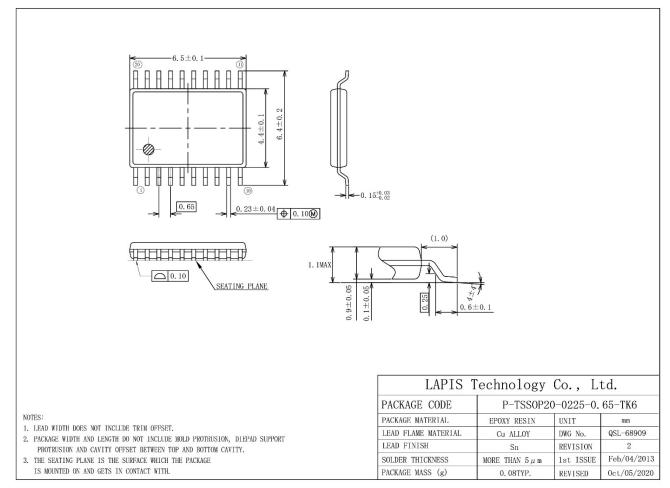




■ APPLICATION CIRCUIT



PACKAGE DIMENSIONS



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact a ROHM sales office for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

PCB Layer	JEDEC 4layers	JEDEC 2layers
PCB	(W/L/t= 76.2 / 114.3 / 1.6 (mm))	
Air cooling condition	Calm(0m/sec)	
Heat resistance(θ ja)	68.48[°C/W]	74.00[°C/W]
Heat resistance(θ jc)	0.61[°C/W]	0.61[°C/W]
Maximum power consumption		
of LSI (PMax)	0.1	3[W]
during 8Ω/1W speaker amp. output		

TjMax of this LSI is 110 °C. TjMax is expressed with the following formulas.

 $TjMax = TaMax + \theta Ja \times PMax$

LAPIS Technology Co., Ltd.

ML22Q244

■ REVISION HISTORY

		Page			
Document No Date	Previous	Current	Description		
		Edition	Edition		
FEDL22Q244-01	Jun. 15, 2021	_	_	Formal 1st edition.	
		8	8	Removed start time SPV _{DD} after starting DV _{DD} (t _{VDD})	
		8	8	Added Oscillation stabilization time, tPUP1 in AC Characteristics	
FEDI 220244 02	FEDL22Q244-02 Jun. 20, 2022	17	17	Added the note when using the playback commands	
FEDL22Q244-02		29	29	Revised the description of STOP/DISCONNECT command	
		33	33	Described heat resistance and TjMax of this LSI	
		_	35	Added "Notes for product usage"	
		-	2	Added application information.	
FEDL22Q244-03	FEDL22Q244-03 Feb. 9, 2024	1	2	Changed shipping form to table format.	
		36	37	Revised the Note.	
FEDL22Q244-04 Oct. 25, 2024			9 9	Changed BUSYB change time from "L" to "H", after over-current	
	0-4-05-0004	0		detection of a speaker amplifier	
	OGI. 25, 2024	9		(Before change) 80µs	
				(After change) 160μs	

Notes for product usage

1. HANDLING OF UNUSED INPUT PINS

Fix the unused input pins to the power pin or GND to prevent to cause the device performing wrong operation or increasing the current consumption due to noise, etc. If the handlings for the unused pins are described in the chapters, follow the instruction.

2. STATE AT POWER ON

At the power on, the internal setting and output of the ports are undefined until the power supply voltage reaches to the recommended operating condition and "L" level is input to the reset pin. Be careful to design the application system does not work incorrectly due to the undefined data of internal setting and output of the ports.

3. CHARACTERISTICS DIFFERENCE BETWEEN THE PRODUCTS

Electrical characteristics, noise tolerance, noise radiation amount, and the other characteristics are different from each product.

When replacing from other product to LAPIS Technology products, please evaluate enough the apparatus/system which implemented LAPIS Technology products.

4. USE ENVIRONMENT

When using LAPIS Technology products in a high humidity environment and an environment where dew condensation, take moisture-proof measures.

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